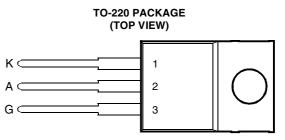
TIC106 SERIES SILICON CONTROLLED RECTIFIERS

BOURNS®

- 5 A Continuous On-State Current
- 30 A Surge-Current
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I_{GT} of 200 μA



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING			VALUE	UNIT
	TIC106D		400	
Repetitive peak off-state voltage (see Note 1)	TIC106M	V	600	v
	TIC106S	V _{DRM}	700	
	TIC106N		800	
	TIC106D		400	
Depetitive peak reverse valtere	TIC106M	N	600	v
Repetitive peak reverse voltage	TIC106S	V _{RRM}	700	
	TIC106N		800	
Continuous on-state current at (or below) 80°C case temperature (see Note 2)		I _{T(RMS)}	5	А
Average on-state current (180° conduction angle) at (or below) 80°C case temperature		1	3.2	A
(see Note 3)		I _{T(AV)}	5.2	
Surge on-state current at (or below) 25°C (see Note 4)			30	А
Peak positive gate current (pulse width \leq 300 μ s)			0.2	А
Peak gate power dissipation (pulse width \leq 300 μ s)			1.3	W
Average gate power dissipation (see Note 5)			0.3	W
Operating case temperature range		P _{G(AV)} T _C	-40 to +110	°C
Storage temperature range			-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds			230	°C

NOTES: 1. These values apply when the gate-cathode resistance R_{GK} = 1 k\Omega.

2. These values apply for continuous dc operation with resistive load. Above 80°C derate linearly to zero at 110°C.

3. This value may be applied continuously under single phase 50 Hz half-sine-wave operation with resistive load. Above 80°C derate linearly to zero at 110°C.

4. This value applies for one 50 Hz half-sine-wave when the device is operating at (or below) the rated value of peak reverse voltage and on-state current. Surge may be repeated after the device has returned to original thermal equilibrium.

5. This value applies for a maximum averaging time of 20 ms.

PRODUCT INFORMATION

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electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	ТҮР	MAX	UNIT	
I _{DRM}	Repetitive peak off-state current	$V_{D} = rated V_{DRM}$	$R_{GK} = 1 \ k\Omega$	$T_{C} = 110^{\circ}C$			400	μA
I _{RRM}	Repetitive peak reverse current	V_{R} = rated V_{RRM}	I _G = 0	$T_{\rm C} = 110^{\circ}{\rm C}$			1	mA
I _{GT}	Gate trigger current	V _{AA} = 12 V	$R_L = 100 \Omega$	t _{p(g)} ≥ 20 μs		5	200	μA
V _{GT}	Gate trigger voltage	V _{AA} = 12 V t _{p(g)} ≥ 20 µs	R _L = 100 Ω R _{GK} = 1 kΩ	$T_{C} = -40^{\circ}C$			1.2	
		V _{AA} = 12 V t _{p(g)} ≥ 20 µs	R _L = 100 Ω R _{GK} = 1 kΩ		0.4	0.6	1	V
		V _{AA} = 12 V t _{p(g)} ≥ 20 μs	R _L = 100 Ω R _{GK} = 1 kΩ	T _C = 110°C	0.2			
Ι _Η	Holding current	$V_{AA} = 12 V$ Initiating I _T = 10 mA	R _{GK} = 1 kΩ	$T_{C} = -40^{\circ}C$			8	mA
		$V_{AA} = 12 V$ Initiating I _T = 10 mA	$R_{GK} = 1 \ k\Omega$				5	
V _T	Peak on-state voltage	I _T = 5 A	(See Note 6)				1.7	V
dv/dt	Critical rate of rise of off-state voltage	$V_D = rated V_D$	$R_{GK} = 1 \ k\Omega$	$T_{\rm C} = 110^{\circ}{\rm C}$		10		V/µs

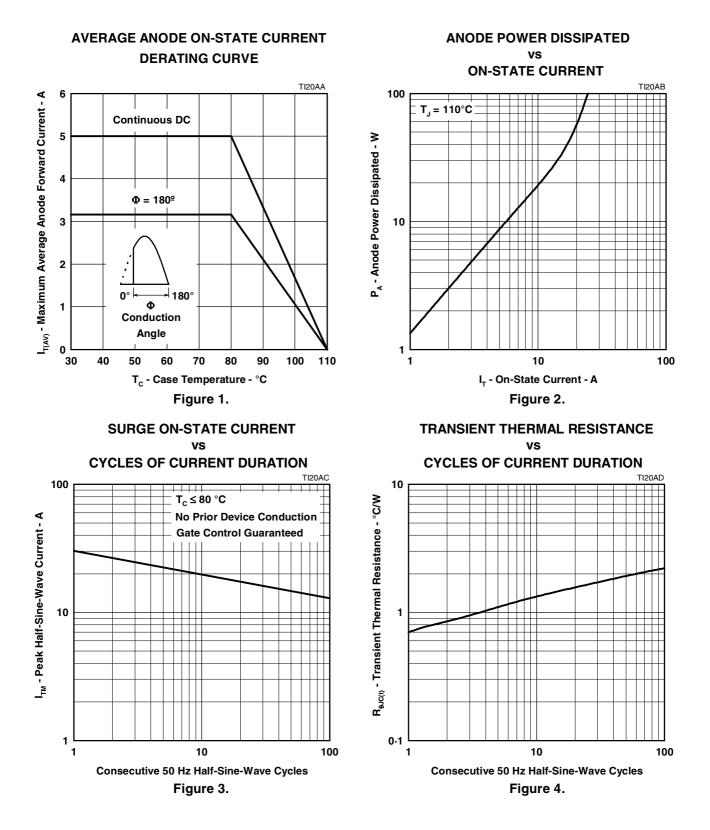
NOTE 6: This parameter must be measured using pulse techniques, $t_p = 300 \ \mu$ s, duty cycle $\le 2 \ \%$. Voltage sensing-contacts, separate from the current carrying contacts, are located within 3.2 mm from the device body.

thermal characteristics

PARAMETER		MIN	ТҮР	MAX	UNIT
R _{θJC}	Junction to case thermal resistance			3.5	°C/W
R _{0JA}	Junction to free air thermal resistance			62.5	°C/W

PRODUCT INFORMATION

THERMAL INFORMATION



PRODUCT INFORMATION

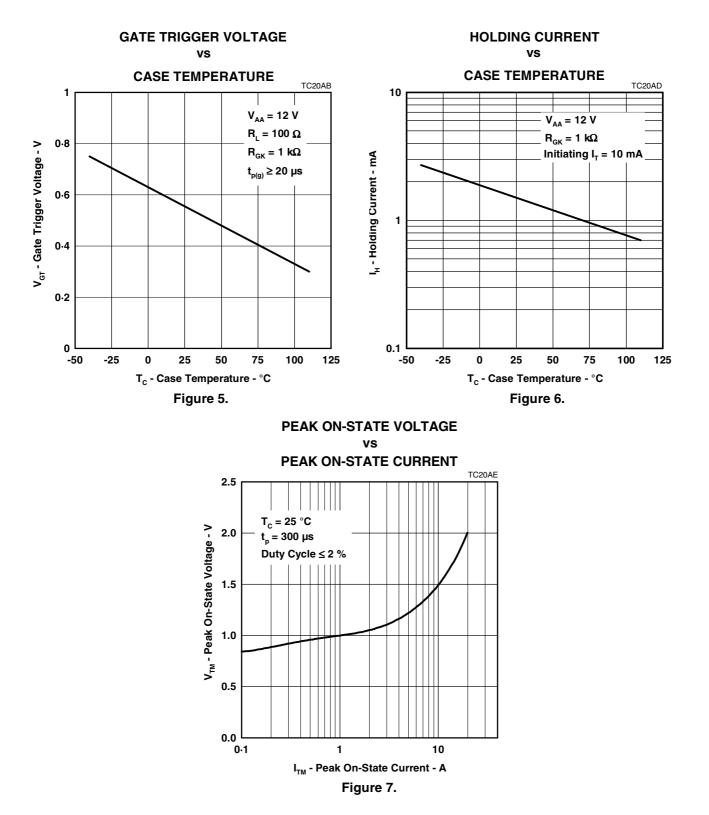
APRIL 1971 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.

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TYPICAL CHARACTERISTICS



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